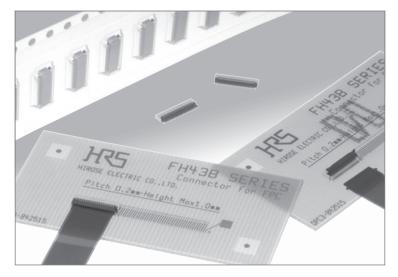
0.2 mm Pitch, 0.9 mm above the board, Flexible Printed Circuit ZIF Connectors

FH43B Series



Features

1. Low-profile, small PCB mounting area

Board footprint: Reduced approximately 45% Weight: Reduced approximately 55% (As compared with Hirose Electric's FH26 Series connectors 51 positions)

2. Easy solderability on the PC board

The soldering leads are on 0.4 mm pitch, exiting on front and back of the connector.

3. Conducive traces on the PCB can run under the connector

No exposed contacts on the bottom of the connector.

4. Easy FPC insertion and reliable electrical connection

Proven Flip Lock actuator allows easy insertion of FPC and provides a tactile sensation when fully closed, confirming complete electrical and mechanical connection.

5. Easy FPC/FFC insertion

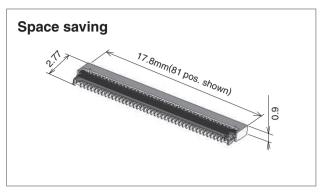
FPC/FFC is self-guided in the connector assuring correct and reliable electrical and mechanical connection.

6. Accepts standard FPC thickness

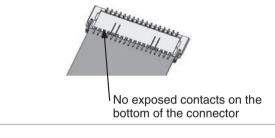
0.2mm thick standard Flexible Printed Circuit (FPC) can be used. This is the only ultra-low profile ZIF connector using standard FPC.

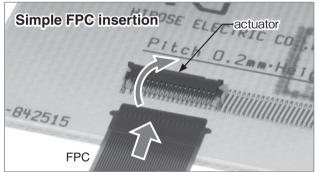
7. Board placement with automatic equipment

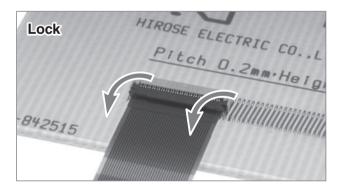
Flat upper surface and tape and reel packaging facilitate vacuum pick-up and placement. Standard reel packaging contains 5000 connectors.

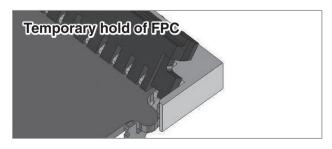


Can be mounted over conductive traces.









Specifications	;

Datingo	Current rating	0.2 A	Operating temperature range	-55 to +85°C (Note 1)	Storage temperature range	-10 to +50°C (Note 2)	
Ratings	Voltage rating	30 Vrms AC	Operating humidity range	Relative humidity 90% max. (No condensation)	Storage humidity range	Relative humidity 90% max. (No condensation)	
Recomme	ended FPC Thic	kness	0.2 ± 0.02 mm, 0	0.2 ± 0.02 mm, Gold plated contact pads			
Item		Specification	ı		Conditions		
1. Insulation resistance	50 M Ω min.			100 V DC			
2. Withstanding voltage	No flashover of	or insulation breakd	lown	90 Vrms AC / one	minute		
3. Contact resistance	100 mΩ max. ★ Including FPC conductor resistance			1 mA, AC max (AC	1 mA, AC max (AC: 1kHz)		
4. Durability	Contact resistance: 100 mΩ max. No damage, cracks, or parts dislocation			10 cycles			
5. Vibration	No electrical discontinuity of 1μ s or longer Contact resistance: 100 m Ω max. No damage, cracks, or parts dislocation			Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 10 cycles in each of the 3 axis			
6. Shock	No electrical discontinuity of $1\mu s$ or longer Contact resistance: 100 m Ω max. No damage, cracks, or parts dislocation			Acceleration of 981m/s ² , 6 ms duration, sine halfwave, 3 cycles in each of the 3 axis			
7. Humidity (Steady state)	Contact resistance: $100 \text{ m}\Omega$ max. Insulation resistance: $50 \text{ M}\Omega$ min. No damage, cracks, or parts dislocation		96 hours at 40°C and humidity of 90 to 95%				
8. Temperature cycle	Contact resistance: $100 \text{ m}\Omega$ max. Insulation resistance: $50 \text{ M}\Omega$ min. No damage, cracks, or parts dislocation			Temperature : -55°C Time: 30 → 2 to 3 5 cycles		→ +85°C→ +15°C to +35°C nutes	
9. Resistance to soldering heat	No deformation of components affecting performance			nce Reflow: At the recommended temperature profile Manual soldering: 350°C ±10°C for 5 seconds			

Note 1. Includes temperature rise caused by current flow.

Note 2. The term "storage" refers to products stored for a long period prior to mounting and use. The operating temperature and humidity range covers the non-conducting condition of installed connectors in storage, shipment or during transportation after board mounting.

Note 3. Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Materials

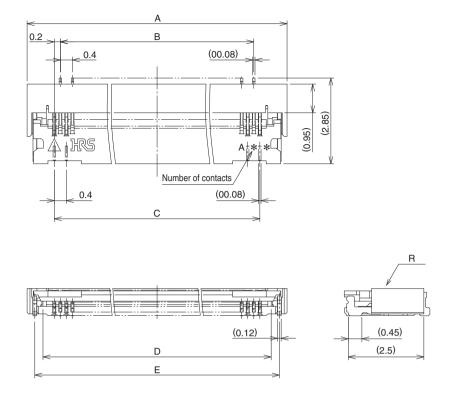
Part	Material	Finish	Remarks
Insulator	LCP	Color:Beige	UL94V-0
Insulator	PA	Color:Black	0L94V-0
Contacts	Dhoonhor bronzo	Gold plated	
Metalfittings	Phosphor bronze	Pure tin reflow plated	

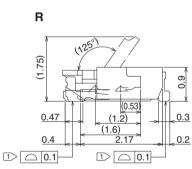
Ordering information

$\frac{FH}{0} \frac{43B}{2} - \frac{51S}{6} - \frac{0.2}{0} \frac{SHW}{6} \frac{(10)}{6}$

Series name : FH	5 Termination type :
2 Series No.: 43B	SHWSMT horizontal staggered row mount type
S Number of positions : 21to81	Plating specifications
Ontact pitch : 0.2mm	(10)Gold plating with nickel barrier

Connector Dimensions





Note $\boxed{1}$ The coplanarity of each terminal lead within specified dimension is 0.1 mm Max.

2. Packaged on tape and reel only. Check packaging specification.

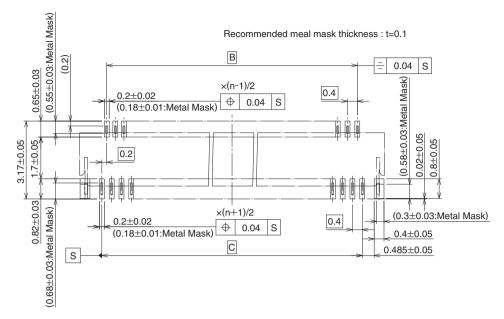
3. Slight variations in color of the plastic compounds do not affect form, fit or function of the connector.

4. After reflow, the terminal plating may change color, however this does not represent a quality issue.

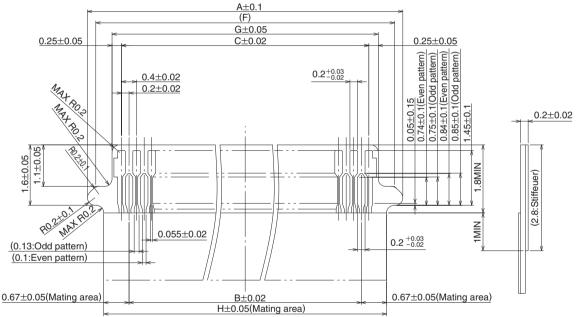
							Unit : mm
Part Number	CL No.	Number of contacts	А	В	С	D	E
FH43B-21S-0.2SHW(10)		21	5.8	3.6	4	4.53	5.29
FH43B-25S-0.2SHW(10)		25	6.6	4.4	4.8	5.33	6.09
FH43B-31S-0.2SHW(10)		31	7.8	5.6	6	6.53	7.29
FH43B-35S-0.2SHW(10)	0580-2803-5-10	35	8.6	6.4	6.8	7.33	8.09
FH43B-41S-0.2SHW(10)		41	9.8	7.6	8	8.53	9.29
FH43B-45S-0.2SHW(10)		45	10.6	8.4	8.8	9.33	10.09
FH43B-51S-0.2SHW(10)	0580-2806-3-10	51	11.8	9.6	10	10.53	11.29
FH43B-61S-0.2SHW(10)	0580-2805-0-10	61	13.8	11.6	12	12.53	13.29
FH43B-71S-0.2SHW(10)	0580-2807-6-10	71	15.8	13.6	14	14.53	15.29
FH43B-81S-0.2SHW(10)		81	17.8	15.6	16	16.53	17.29

Note1. Tape and reel packaging (5,000 pieces/reel). Order by number of reels. I Init I mm

■Recommended PCB mounting pattern and metal mask dimensions



Recommended FPC Dimensions



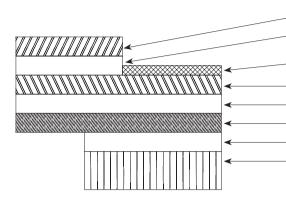
Recommended FPC construction

Part Number	CL No.	Number of contacts	В	С	F	G	Н
FH43B-21S-0.2SHW(10)		21	3.6	4	5.3	4.5	4.94
FH43B-25S-0.2SHW(10)		25	4.4	4.8	6.1	5.3	5.74
FH43B-31S-0.2SHW(10)		31	5.6	6	7.3	6.5	6.94
FH43B-35S-0.2SHW(10)	0580-2803-5-10	35	6.4	6.8	8.1	7.3	7.74
FH43B-41S-0.2SHW(10)		41	7.6	8	9.3	8.5	8.94
FH43B-45S-0.2SHW(10)		45	8.4	8.8	10.1	9.3	9.74
FH43B-51S-0.2SHW(10)	0580-2806-3-10	51	9.6	10	11.3	10.5	10.94
FH43B-61S-0.2SHW(10)	0580-2805-0-10	61	11.6	12	13.3	12.5	12.94
FH43B-71S-0.2SHW(10)	0580-2807-6-10	71	13.6	14	15.3	14.5	14.94
FH43B-81S-0.2SHW(10)		81	15.6	16	17.3	16.5	16.94
	•						

Unit : mm

■FHB Series FPC

1. Using Single-sided FPC



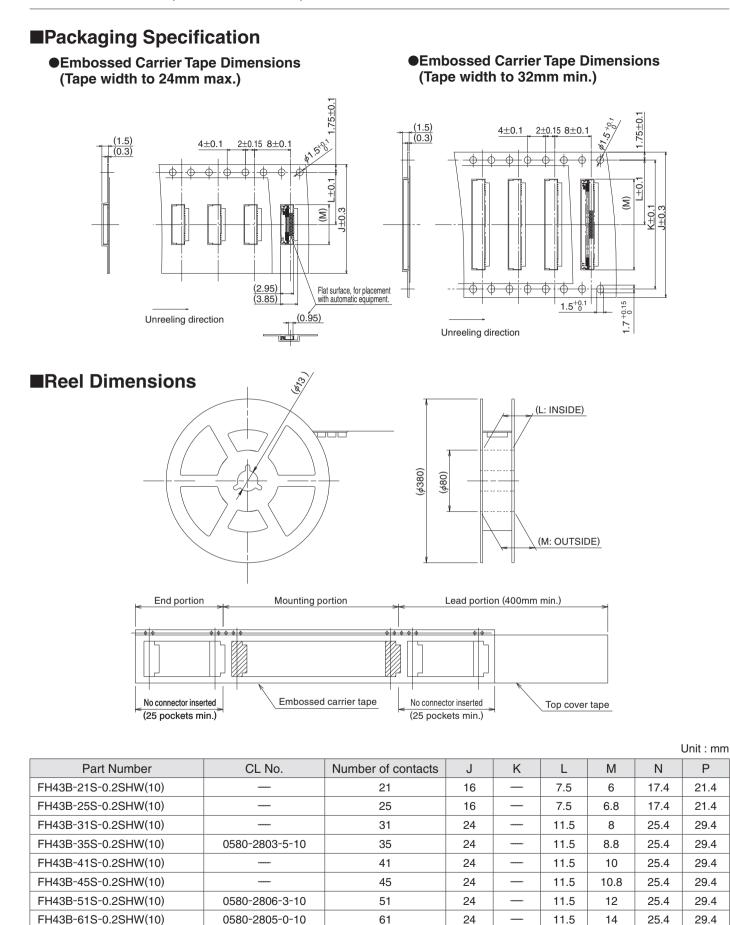
Material Name	Material	Material Thickness (µm)
Covering film layer	Polyimide 1 mil thick.	(25)
Cover adhesive		(25)
Surface treatment	$0.2\mu m$ thick gold plated over 1 to $6\mu m$ nickel underplating	4
Copper foil	Cu 1/3oz	12
Base adhesive	Thermosetting adhesive	10
Base film	Polyimide 1/2mil thick	15
Reinforcement material adhesive	Thermosetting adhesive	30
Stiffener	Polyimide 5 mil thick	125
	Total	194

2. Using Double-sided FPC	Material Name	Material	Material Thickness (µm)
	- Covering film layer	Polyimide 1 mil thick.	(25)
	- Cover adhesive		(25)
	- Surface treatment	$0.2\mu m$ thick gold plated over 1 to $6\mu m$ nickel underplating	4
	Through-hole copper	Cu	12
	Copper foil	Cu 1/3oz	12
← ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─ ─	Base adhesive	Thermosetting adhesive	—
<	Base film	Polyimide 1/2mil thick	13
· · · · · · · · · · · · · · · · · · ·	Base adhesive	Thermosetting adhesive	_
	 Copper foil 	Cu 1/3oz	(12)
A A A A A A A A A A	Cover adhesive	Thermosetting adhesive	25
<i>\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\</i>	Covering film layer	Polyimide 1/2 mil thick	13
************************************	Reinforcement material adhesive	Thermosetting adhesive	25
· · · · · · · · · · · · · · · · · · ·	Stiffener	Polyimide 4 mil thick	100
		Total	204

* To prevent release of the FPC due to its bending, use of the double sided FPC with copper foil on the back side is NOT RECOMMENDED.

3. Precautions

- 1. This specification is a recommendation for the construction of the FH43B Series FPC and FFC (t=0.2 \pm 0.02).
- 2. For details about the construction, please contact the FPC/FFC manufacturers.



6

FH43B-71S-0.2SHW(10)

FH43B-81S-0.2SHW(10)

0580-2807-6-10

71

81

24

32

28.4

11.5

14.2

16

18

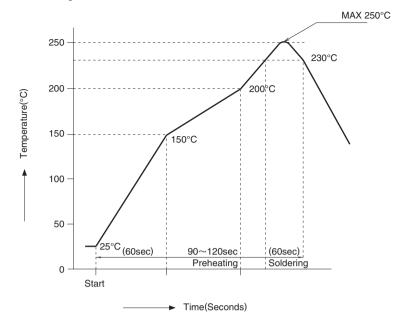
25.4

33.4

29.4

37.4

Temperature Profile



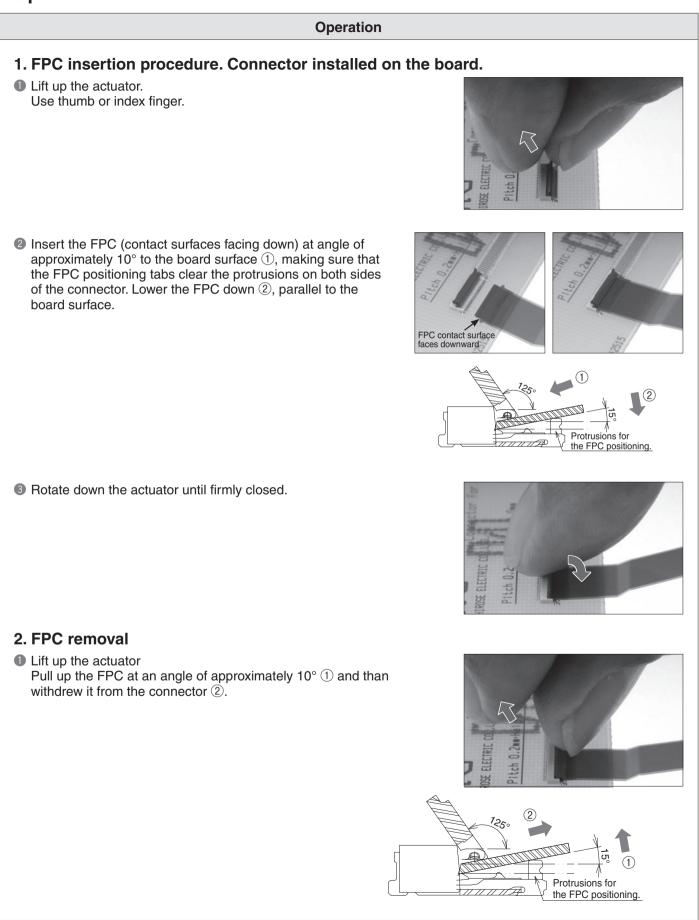
^oC HRS test condition

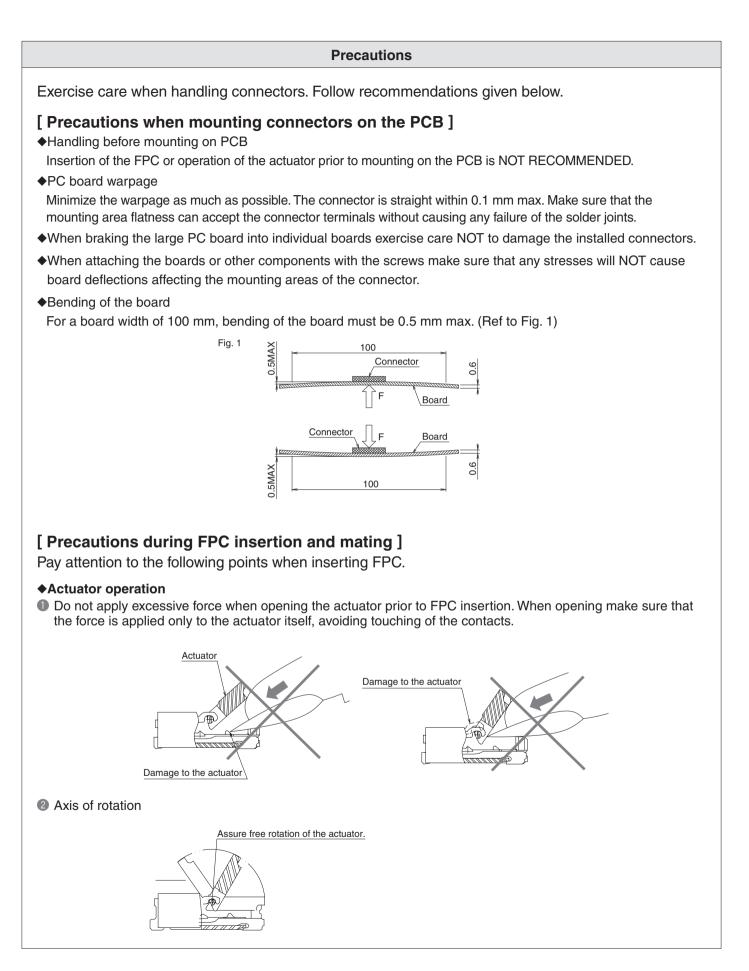
Solder method :	Reflow, IR/hot air
Environment :	Room air
Solder composition	: Paste, 96.5%Sn/3.0%Ag/0.5%Cu
	(Senju Metal Industry, Co., Ltd.'s Part
	Number:M705-221CM5-32-10.5)
Test board :	Glass epoxy 100mm×72.5mm×0.8mm thick
Land dimensions :	0.2mm×0.65mm, 0.2mm×0.82mm
Metal mask :	0.18×0.55, 0.18×0.68×0.1mm thick

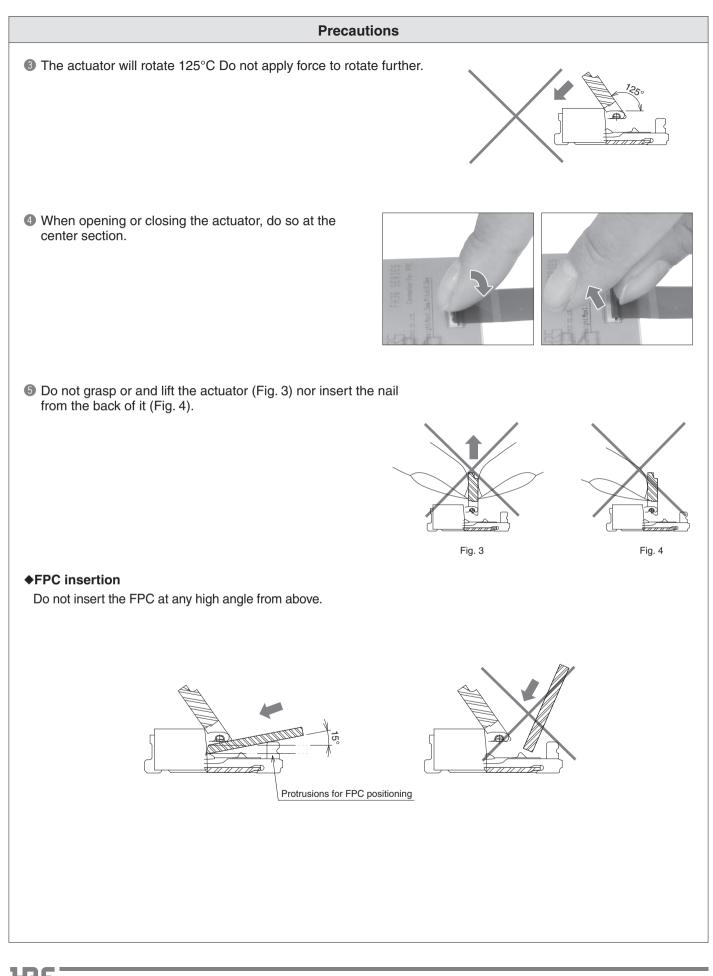
The temperature profiles shown are based on the above conditions.

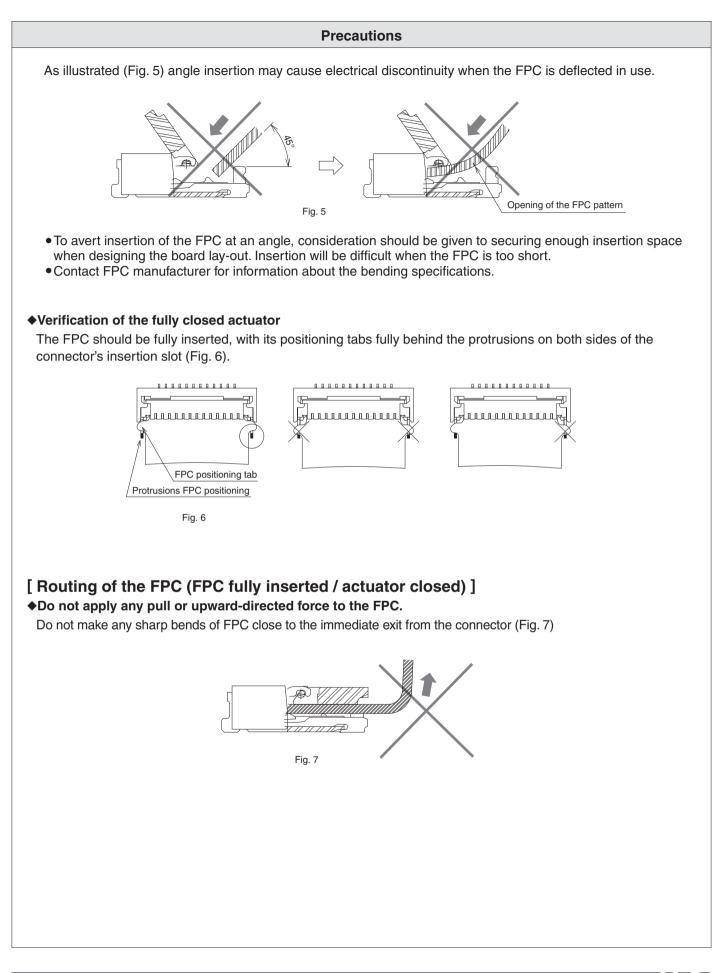
In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

Operation and Precautions







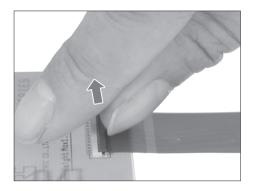


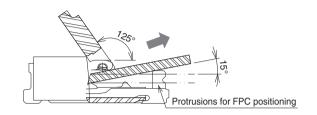
Precautions

[Removing of the FPC]

♦Rotate the actuator to the fully open position (max. angle of 125°C)

Lift the FPC approximately 10°C (making sure that the positioning tabs clear the protrusions on both sides) and carefully withdraw it from the connector.





[Other Precautions]

Hand Soldering Precautions

When hand soldering:

- Do not perform reflow or hand soldering with the FPC inserted in the connector.
- O not apply excessive heat or touch the soldering iron anywhere other than the connector leads.
- O not use excessive amount of solder or flux compounds.

Operation of the actuator or contacts may be affected by excessive amounts of solder or flux compounds.



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